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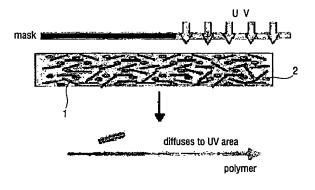
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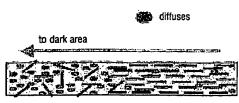
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[Continued on next page]

(54) Title: METHOD FOR PHOTO-EMBOSSING A MONOMER-CONTAINING LAYER





(57) Abstract: The invention relates to a method for photo-embossing a monomer-containing layer for obtaining a photovoltaic cell, a light emitting diode (LED), or a light emitting electrochemical cell (LEC) by the steps of: (a) optionally providing one or more layers onto the surface of the monomer-containing layer; (b) irradiating through a mask a layer consisting of a homogeneous blend of at least two different compounds, at least one of which is a polymerizable monomer, to obtain a monomer-containing layer with exposed and non-exposed areas; (c) optionally providing further layers onto the surface of the monomer-containing layer; (d) expanding the exposed or the non-exposed areas by diffusing at least one of the monomers to the exposed areas to obtain a corrugated surface of the layer; or interchanging steps c) and d).



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